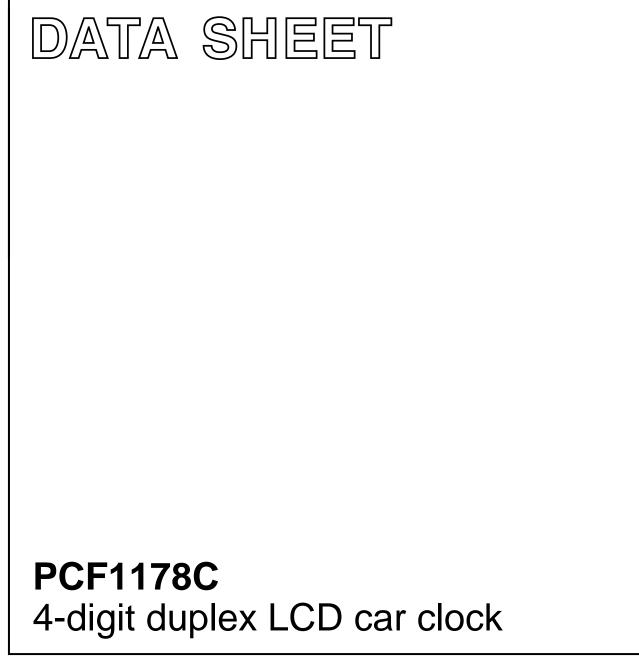
INTEGRATED CIRCUITS



Product specification Supersedes data of September 1993 File under Integrated Circuits, IC16 1997 Apr 16



PCF1178C

FEATURES

- Internal voltage regulator is electrically programmable for various LCD voltages
- Time calibration is electrically programmable (no trimming capacitor required)
- · LCD voltage adjusts with temperature for good contrast
- 4.19 MHz oscillator
- 12-hour or 24-hour mode
- Operating ambient temperature: -40 to +85 °C
- 28-lead plastic SMD (SO28)
- 1 Hz set mode.

ORDERING INFORMATION

GENERAL DESCRIPTION

The PCF1178C is a single chip, 4.19 MHz CMOS car clock circuit providing hours, minutes and seconds functions. It is designed to drive a 4-digit duplex liquid crystal display (LCD).

Two external single-pole, single-throw switches will accomplish all time setting functions. Time calibration and voltage regulator are electrically programmable via an on-chip EEPROM. The circuit is battery-operated via an internal voltage regulator and an external resistor.

TYPE NUMBER		PACKAGE			
ITPE NUMBER	NAME	DESCRIPTION	VERSION		
PCF1178CT	SO28	plastic small outline package; 28 leads; body width 7.5 mm ⁽¹⁾	SOT136-1		
PCF1178CU	_	uncased chip in tray ⁽²⁾	_		
PCF1178CU/10	_	chip-on-film frame carrier (FFC) ⁽²⁾	_		
PCF1178CU/5	_	unsawn wafer ⁽²⁾	_		

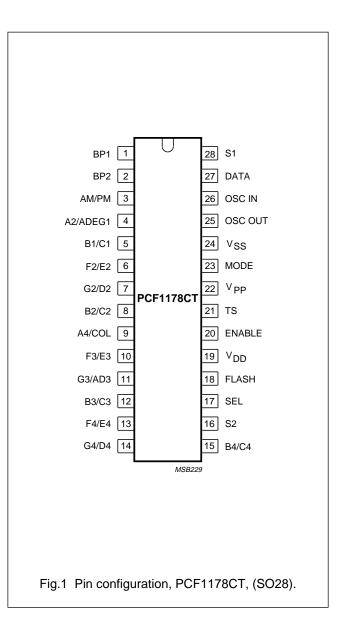
Notes

- 1. See Fig.1 and Chapter "Package outline" for pin layout and package details.
- 2. See Chapter "Chip dimensions and bonding pad locations" for pad layout and package details.

PCF1178C

PINNING

SYMBOL	PIN	DESCRIPTION
BP1	1	backplane 1
BP2	2	backplane 2
AM/PM	3	segment driver
A2/ADEG1	4	segment driver
B1/C1	5	segment driver
F2/E2	6	segment driver
G2/D2	7	segment driver
B2/C2	8	segment driver
A4/COL	9	segment driver
F3/E3	10	segment driver
G3/AD3	11	segment driver
B3/C3	12	segment driver
F4/E4	13	segment driver
G4/D4	14	segment driver
B4/C4	15	segment driver
S2	16	minute adjustment input
SEL	17	EEPROM select input
FLASH	18	colon option input
V _{DD}	19	positive supply voltage
ENABLE	20	enable input (for S1 and S2)
TS	21	test speed-up mode input
V _{PP}	22	programming voltage input
MODE	23	12/24-hour mode select input
V _{SS}	24	negative supply voltage
OSC OUT	25	oscillator output
OSC IN	26	oscillator input
DATA	27	EEPROM data input
S1	28	hour adjustment input



PCF1178C

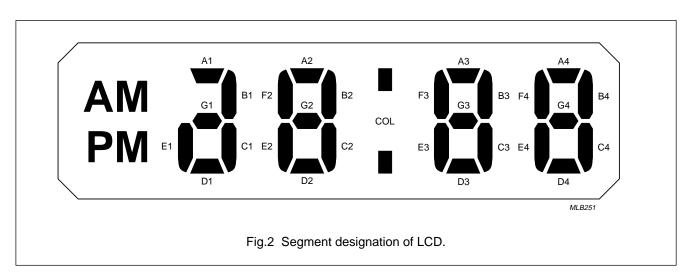
FUNCTIONAL DESCRIPTION AND TESTING

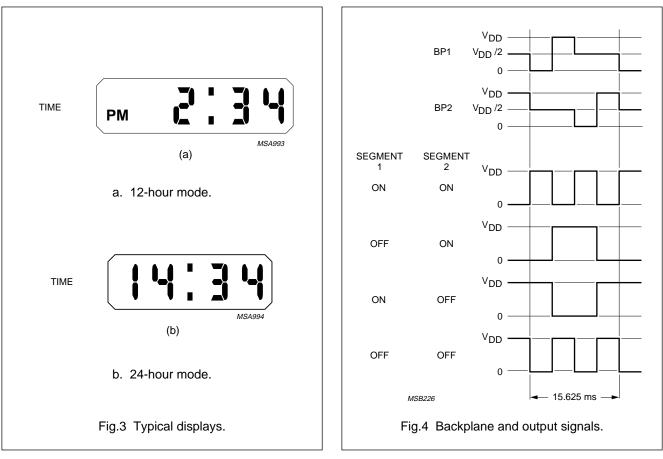
Outputs

The circuit outputs 1 : 2 multiplexed data (duplex) to the LCD. Generation of BP1 and BP2 (three-level backplane signals) and the output signals are shown in Fig.4.

The average voltages across the segments are:

- 1. $V_{ON(RMS)} = 0.79 V_{DD}$
- 2. $V_{OFF(RMS)} = 0.35 V_{DD}$.





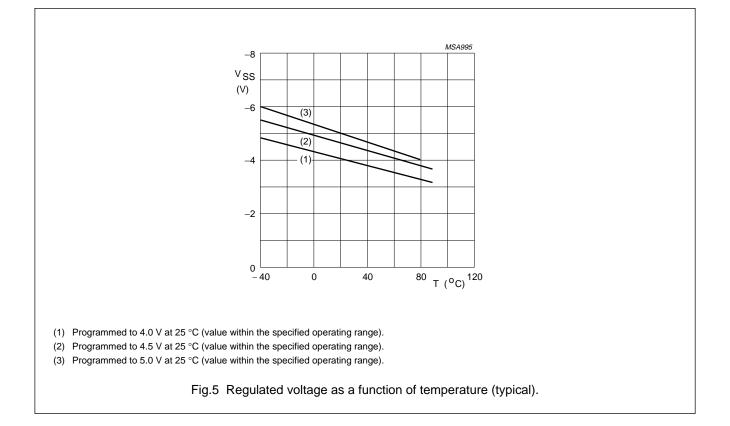
PCF1178C

LCD voltage (see Fig.5)

The adjustable voltage regulator controls the supply voltage (see Section "LCD voltage programming") in relation to temperature for good contrast, for example when $V_{DD} = 4.5$ V at +25 °C, then:

 V_{DD} = 3 to 4 V at +85 °C.

 V_{DD} = 5 to 6 V at -40 °C.



PCF1178C

4-digit duplex LCD car clock

12/24-hour mode

Operation in 12-hour or 24-hour mode is selected by connecting MODE to V_{DD} or V_{SS} respectively. If MODE is left open-circuit and a reset occurs, the mode will change from 12-hour to 24-hour mode or vice versa.

Power-on

After connecting the supply, the start-up mode is:

MODE connected to V_{DD}: 12-hour mode, 1:00 AM.

MODE connected to V_{SS}: 24-hour mode, 0:00.

MODE left open-circuit: 24-hour mode, 0:00 or 1:00.

Colon

If FLASH is connected to V_{DD} the colon pulses at 0.5 Hz. If FLASH is connected to V_{SS} the colon is static.

Time setting

Switch inputs S1 and S2 have a pull-up resistor to facilitate the use of single-pole, single-throw contacts. A debounce circuit is incorporated to protect against contact bounce and parasitic voltages.

Set enable

Inputs S1 and S2 are enabled by connecting ENABLE to V_{DD} or disabled by connecting to $V_{\text{SS}}.$

Set hours

When S1 is connected to V_{SS} the hours displayed advances by one and after one second continues with one advance per second until S1 is released (auto-increment).

Set minutes

When S2 is connected to V_{SS} the time displayed in minutes advances by one and after one second continues with two advances per second until S2 is released (auto-increment). In addition to minute correction, the seconds counter is reset to zero.

Segment test/reset

When S1 and S2 are connected to V_{SS} , all LCD segments are switched ON. Releasing switches S1 and S2 resets the display. No reset occurs when DATA is connected to V_{SS} (overlapping S1 and S2).

Test mode

When TS is connected to V_{DD} , the device is in normal operating mode. When connecting TS to V_{SS} all counters (seconds, minutes and hours) are stopped, allowing quick testing of the display via S1 and S2 (debounce and auto-increment times are 64 times faster). TS has a pull-up resistor but for reasons of safety it should be connected to V_{DD} .

EEPROM

 V_{PP} has a pull-up resistor but for reasons of safety it should be connected to $V_{\text{DD}}.$

LCD voltage programming

To enable LCD voltage programming, SEL is set to open-circuit and a level of $V_{DD} - 5$ V is applied to V_{PP} (see Fig.6). The first pulse (t_E) applied to the DATA input clears the EEPROM to give the lowest voltage output. Further pulses (t_L) will increment the output voltage by steps of typically 150 mV ($T_{amb} = 25$ °C). For programming, measure $V_{DD} - V_{SS}$ and apply a store pulse (t_W) when the required value is reached. If the maximum number of steps (n = 31) is reached and an additional pulse is applied the voltage will return to the lowest value.

Time calibration

To compensate for the tolerance in the quartz crystal frequency which has been positively offset (nominal deviation $+60 \times 10^{-6}$) by capacitors at the oscillator input and output, a number (n) of 262144 Hz pulses are inhibited every second of operation.

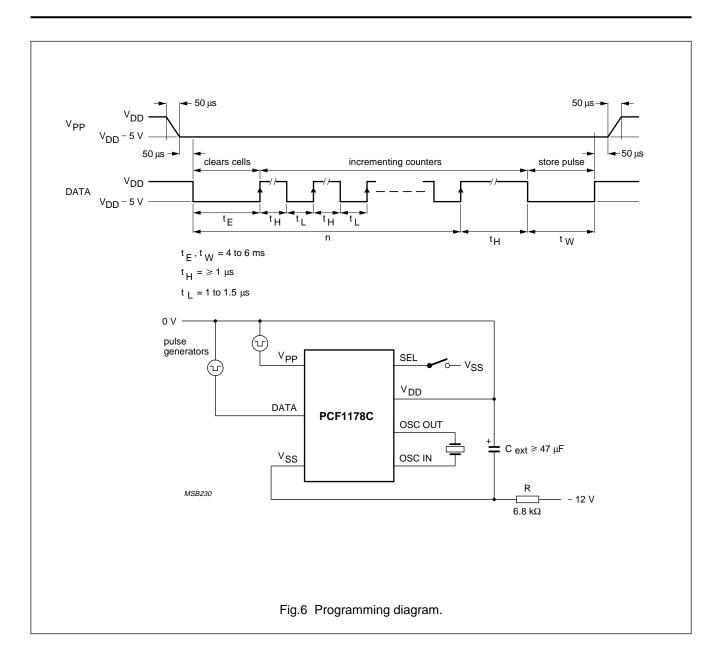
The number (n) is stored in a non-volatile memory which is achieved by the following steps (see Fig.6):

- 1. Set SEL to V_{SS} and a level of V_{DD} 5 V to V_{PP}
- 2. The quartz-frequency deviation $\Delta f/f$ is measured and (n) is calculated (see Table 1)
- 3. A first pulse t_E is applied to the DATA input clears the EEPROM to give the highest backplane frequency
- 4. The calculated pulses (n) are entered in (t_H, t_L). If the maximum backplane period is reached and an additional pulse is applied the period will return to the lowest value.
- 5. The backplane period is controlled and when correct fixed by applying the store pulse t_W
- 6. Release SEL and VPP.

Table 1 Time calibration ($\Delta t = 7.63 \,\mu s$; SEL at V_{SS})

OSCILLATOR-FREQUENCY DEVIATION $\Delta f/f$ (× 10 ⁻⁶)	NUMBER OF PULSES (n)	BACKPLANE PERIOD (ms)
0	0	15.625
+3.8	1	15.633
+7.6	2	15.641
+11.4	3	15.648
+117.8	31	15.861

PCF1178C



PCF1178C

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{DD}	supply voltage	with respect to V _{SS}	-	8	V
I _{DD}	supply current	V _{SS} = 0 V; note 1	-	3	mA
VI	input voltage	all pins except VPP and DATA	-0.3	V _{DD} + 0.3	V
		pins V _{PP} and DATA	-3	V _{DD} + 0.3	V
T _{amb}	operating ambient temperature		-40	+85	°C
T _{stg}	storage temperature		-55	+125	°C

Note

1. Connecting the supply voltage with reverse polarity, will not harm the circuit, provided the current is limited to 10 mA by an external resistor.

HANDLING

Inputs and outputs are protected against electrostatic discharges in normal handling. However, to be totally safe, it is advisable to take handling precautions appropriate to handling MOS devices. Advice can be found in *"Data Handbook IC16, General, Handling MOS Devices"*.

PCF1178C

CHARACTERISTICS

 V_{DD} = 3 to 6 V; V_{SS} = 0 V; T_{amb} = -40 to +85 °C; crystal: f = 4.194304 MHz; R_s = 50 Ω ; C_L = 12 pF; maximum frequency tolerance = ±30 × 10⁻⁶; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Supply		1			1	
V _{DD}	supply voltage	voltage regulator programmed to 4.5 V at T_{amb} = 25 °C	3	-	6	V
ΔV_{DD}	supply voltage variation	S1 or S2 closed	-	_	50	mV
тс	supply voltage variation due		-	-0.35	-	%/K
	to temperature	V _{DD} = 4.5 V	-	-16	-	mV/K
I _{DD}	supply current	note 1	700	950	-	μA
C _{EXT}	capacitance	external capacitor	47	-	-	μF
Oscillator						
t _{osc}	start time		-	-	200	ms
Δf/f	frequency deviation	nominal n = 0	0	60 × 10 ⁻⁶	110 × 10 ⁻⁶	
Δf/f	frequency stability	$\Delta V_{DD} = 100 \text{ mV}$	_	_	1 × 10 ⁻⁶	
R _{fb}	feedback resistance		300	1000	3000	kΩ
C _i	input capacitance		-	16	-	pF
Co	output capacitance		-	27	-	pF
Inputs						
R _o	pull-up resistance	S1, S2, TS, SEL and DATA	45	90	180	kΩ
R _O	pull-up/pull-down resistance	MODE	100	300	1000	kΩ
IIL	leakage current	ENABLE, FLASH	-	_	2	μA
t _d	debounce time	S1 and S2 only	30	65	100	ms
V _{PP} progra	amming voltage					
I _{O2}	output current	$V_{PP} = V_{DD} - 5 V$	70	_	700	μA
		during programming	-	500	-	μA
Backplane	e (high and low levels)		1	1	1	Į
R _{BP}	output resistance	±100 μA	-	_	3	kΩ
Segment	1				1	
R _{SEG}	output resistance	±100 μA	-	_	5	kΩ
LCD		1 ·	1	1	1	1
V _{offset(DC)}	DC offset voltage	200 kΩ/1 nF	-	-	50	mV
R _{SEG}						

Note

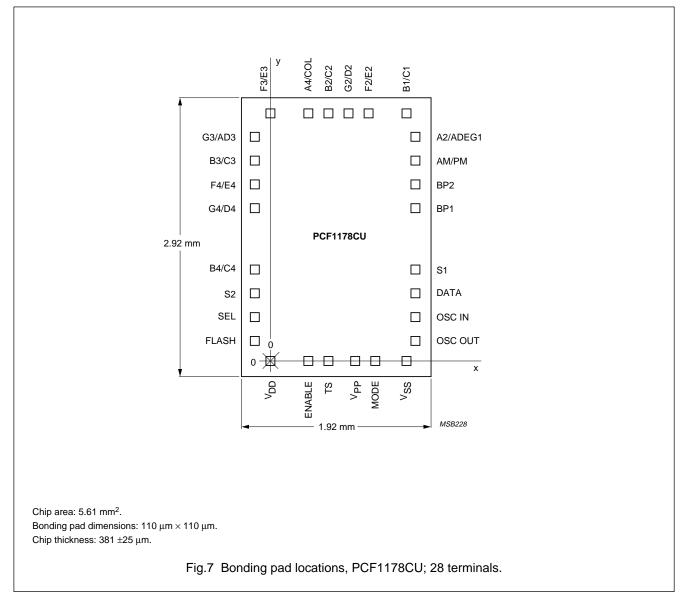
1. A suitable resistor (R) must be selected (example):

a) $V_{DD} = 5 \text{ V}$; R max. (12 V - 5 V)/700 μ A $= 10 \text{ k}\Omega$.

- b) $V_{DD} = 5 \text{ V}$; R typ. (12 V 5 V)/900 μ A = 7.8 k Ω (more reserve).
- c) I_{DD} must not exceed 3 mA.

PCF1178C

CHIP DIMENSIONS AND BONDING PAD LOCATIONS



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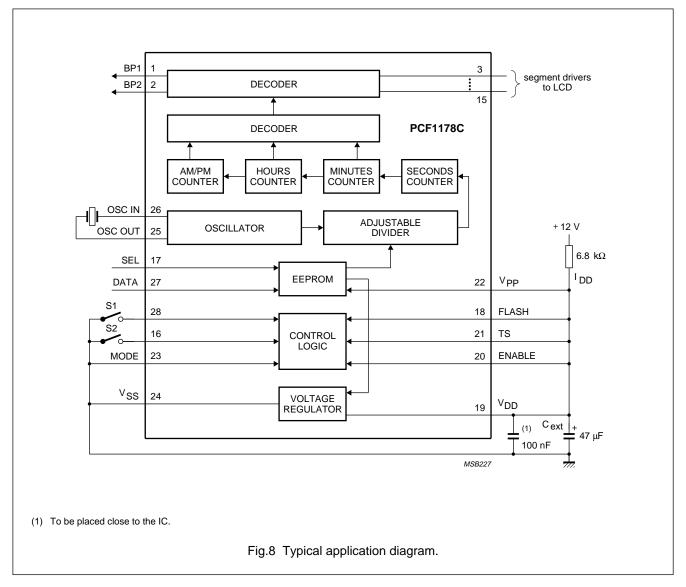
Table 2Bonding pad locations (dimensions in μm)

All x/y coordinates are referenced to the bottom left pad (V_{DD}), see Fig.7.

PAD	x	У	PAD	x	У
S1	1 4 9 0	881	G4/D4	-86	1588
DATA	1490	639	F4/E4	-86	1808
OSC IN	1 4 9 0	408	B3/C3	-86	2028
OSC OUT	1 4 9 0	188	G3/AD3	-86	2248
V _{SS}	1352	0	F3/E3	-48	2476
MODE	969	0	A4/COL	352	2476
V _{PP}	770	0	B2/C2	552	2476
TS	506	0	G2/D2	752	2476
ENABLE	306	0	F2/E2	952	2476
V _{DD}	0	0	B1/C1	1352	2476
FLASH	-86	188	A2/ADEG1	1490	2248
SEL	-86	408	AM/PM	1490	2028
S2	-86	628	BP2	1490	1808
B4/C4	-86	848	BP1	1490	1588
chip corner (max. value)	-305	–175			

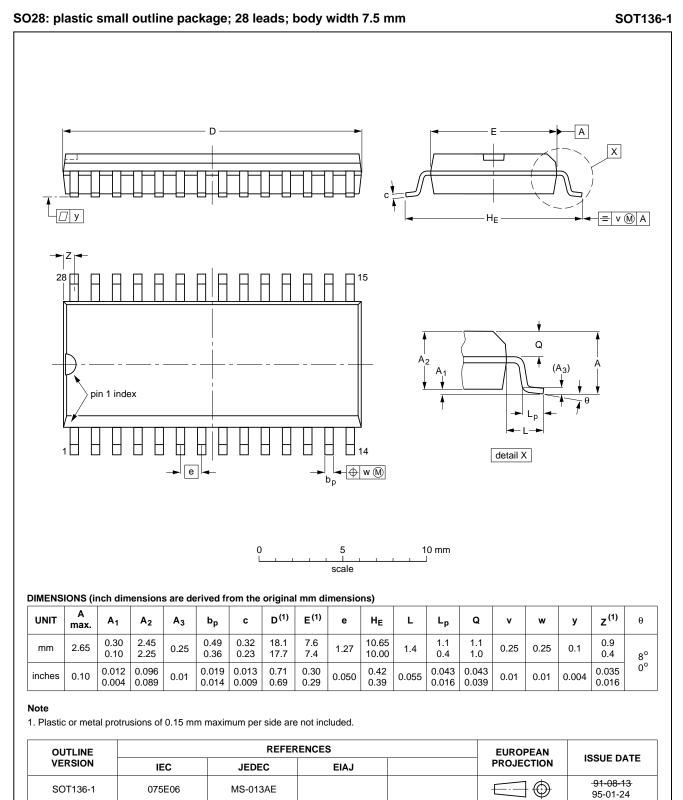
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APPLICATION INFORMATION



PCF1178C

PACKAGE OUTLINE



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SOLDERING

Introduction

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mounted components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mounted ICs, or for printed-circuits with high population densities. In these situations reflow soldering is often used.

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our *"IC Package Databook"* (order code 9398 652 90011).

Reflow soldering

Reflow soldering techniques are suitable for all SO packages.

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement.

Several techniques exist for reflowing; for example, thermal conduction by heated belt. Dwell times vary between 50 and 300 seconds depending on heating method. Typical reflow temperatures range from 215 to 250 °C.

Preheating is necessary to dry the paste and evaporate the binding agent. Preheating duration: 45 minutes at 45 °C.

Wave soldering

Wave soldering techniques can be used for all SO packages if the following conditions are observed:

- A double-wave (a turbulent wave with high upward pressure followed by a smooth laminar wave) soldering technique should be used.
- The longitudinal axis of the package footprint must be parallel to the solder flow.
- The package footprint must incorporate solder thieves at the downstream end.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Maximum permissible solder temperature is 260 °C, and maximum duration of package immersion in solder is 10 seconds, if cooled to less than 150 °C within 6 seconds. Typical dwell time is 4 seconds at 250 °C.

A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

Repairing soldered joints

Fix the component by first soldering two diagonallyopposite end leads. Use only a low voltage soldering iron (less than 24 V) applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 °C. When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320 °C.

Product specification

PCF1178C

DEFINITIONS

Data sheet status				
Objective specification	This data sheet contains target or goal specifications for product development.			
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.			
Product specification	This data sheet contains final product specifications.			
Limiting values				
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.				
Application information				

Where application information is given, it is advisory and does not form part of the specification.

LIFE SUPPORT APPLICATIONS

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